# **Special Issue**

### New Advances in Micro-Devices

### Message from the Guest Editors

In recent years, there has been an important growth of micro-device proposals in various fields, including biomedical, automotive, and aerospace fields. This growth is due to the strong market interest in materials other than silicon, such as polymers, glass, and composite materials, which allow equally performing micro-devices to be obtained, but at a much lower cost thanks to the availability of high-performance micromanufacturing technologies. Their features of precision and reproducibility, as well as their low cost and scaling suitability, make their use more appealing for innovative microfabrication. Smart manufacturing techniques, starting from standard additive manufacturing to twophoton fabrication, also offer the ability to quickly and reliably prototype micro-devices to reduce the risk of costly rework. The advent of Industry 4.0 also given a strong push to the monitoring of processes through sensors, facilitating the application of Digital Twin techniques that digitally reproduce processes in a rather realistic way, allow an accurate assessment to be made on the digital concept with important implications in terms of the feasibility of implementing the microdevice.

### **Guest Editors**

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#### Deadline for manuscript submissions

closed (20 November 2023)



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### Editor-in-Chief

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